

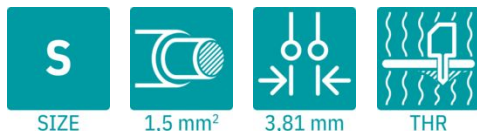
MC 1,5/13-GU-3,81 P19 THR - PCB header



1532514

<https://www.phoenixcontact.com/us/products/1532514>

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PCB headers, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of rows: 1, number of positions: 13, product range: MC 1,5/..-GU-THR, pitch: 3.81 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 1.9 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: Box packaging

Your advantages

- Designed for integration into the SMT soldering process
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- Easy PCB replacement thanks to plug-in modules
- Well-known mounting principle allows worldwide use

Commercial data

Item number	1532514
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA02
Product key	AABTBI
GTIN	4067923001077
Customs tariff number	85366930
Country of origin	US

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Technical data

Product properties

Product type	PCB headers
Product family	MC 1,5/...-GU-THR
Product line	COMBICON Connectors S
Number of positions	13
Pitch	3.81 mm
Number of rows	1
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Contact resistance	1.3 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	THR soldering / wave soldering
Pin layout	Linear pinning

Processing notes

Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 μm - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 μm - 5 μm Sn)

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Metal surface soldering area (middle layer)	Nickel (1.3 µm - 3 µm Ni)
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Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIla
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	200 °C

Dimensions

Dimensional drawing	
Pitch	3.81 mm
Width [w]	50.92 mm
Height [h]	9.4 mm
Length [l]	8.7 mm
Installed height	7.5 mm
Solder pin length [P]	1.9 mm
Pin dimensions	0.8 x 0.8 mm

PCB design

Hole diameter	1.4 mm
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Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
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Contact holder in insert Requirements >20 N	Test passed
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Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	5 N
Withdraw strength per pos. approx.	4 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	6

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2.5 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R ₁	1.3 mΩ
Contact resistance R ₂	1.6 mΩ
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

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Climatic test

Specification	EN ISO 22479:2022-06
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Thermal stress	105 °C/168 h
Power-frequency withstand voltage	1.39 kV

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	50 m/s ² (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

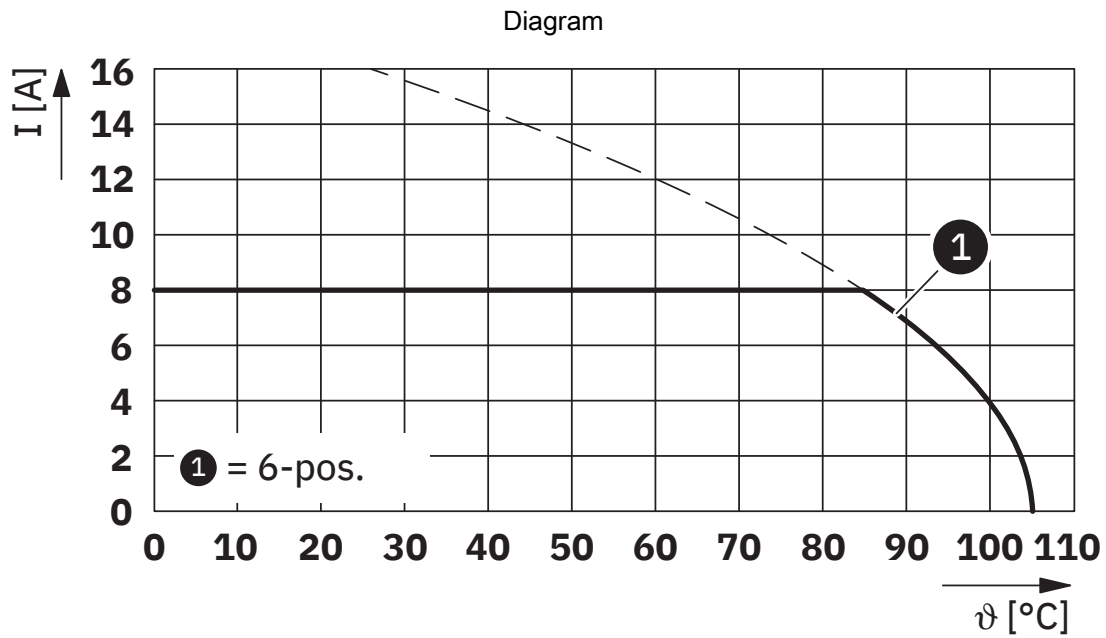
Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 105 °C (dependent on the derating curve)

Packaging specifications

Type of packaging	Box packaging
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Drawings



Type: MC 1,5/...-ST-3,81 with MC 1,5/...-GU-3,81 P... THR

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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1532514>

 cULus Recognized Approval ID: E60425-20110128				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B	300 V	8 A	-	-
D	300 V	8 A	-	-

 VDE Zeichengenehmigung Approval ID: 40011723				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine	160 V	8 A	-	-

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637
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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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